



Product Change Notification

Change Notification #: 119403-00

Change Title: Select Intel® Server Board M10JNP2SB, Disti 5 pack,
PCN 119403-00, Product Design,
Bios and firmware updates

Date of Publication: January 06, 2023

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*	January 24, 2023
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Board M10JNP2SB. Update of the System Firmware installed at the Factory:

- BIOS update from revision 7.218 to revision 7.219.
- Integrated Baseboard Management Controller (BMC) firmware update from revision 8100.01.10 to 8100.01.11.

The system software update package, including the release notes for each, is available for download from <http://www.intel.com/support>. Please refer to the software release notes for a list of changes.

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes but encourages customers to understand the change and determine the impact on their applications. For that reason, Intel recommends that the customer perform a standard level of evaluation. Customers can download and evaluate the latest BIOS/ BMC release notes for more information at <http://www.intel.com/support>.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Post Change TA
Intel® Server Board M10JNP2SB, Disti 5 pack	DBM10JNP2SB	999PL9	K73063-013	K73063-014

PCN Revision History:

Date of Revision:

January 06, 2023

Revision Number:

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Reason:

Originally Published PCN



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No response from customers will be deemed an acceptance of the change, and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below.

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Asia Pacific/PRC Contact: apacgccb@intel.com

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